

RoHS Reach Halogen Free Pb Free

| 交货型号 | C1608X6S0J685MT**** | |
|------|---------------------|---|
| 用途 | 一般等级 | |
| 特点 | General 一般(~75V) | |
| 系列 | C1608 [EIA 0603] | 6 |
| 状态 | ▲ 量产体制(新设计非推荐) | B |

| 尺寸 | | |
|-------------------|------------------------------------|--|
| 长度(L) | 1.60mm ±0.20mm | |
| 宽度(W) | 0.80mm ±0.20mm | |
| 厚度(T) | 0.80mm ±0.20mm | |
| 端子宽度(B) | 0.20mm Min. | |
| 端子间隔(6) | 0.30mm Min. | |
| 推荐焊盘布局(PA) | 0.70mm to 1.00mm(Flow Soldering) | |
| 1世行/产益1 /可([[A]) | 0.60mm to 0.80mm(Reflow Soldering) | |
| 推荐焊盘布局(PB) | 0.80mm to 1.00mm(Flow Soldering) | |
| 1世行/产益1µ/ŋ (ГD) | 0.60mm to 0.80mm(Reflow Soldering) | |
| 推荐焊盘布局(PC) | 0.60mm to 0.80mm(Flow Soldering) | |
| 1世什/开血小川(10,00) | 0.60mm to 0.80mm(Reflow Soldering) | |

| 电气特性 | | |
|------|-----------------------|--|
| 电容 | 6.8 µ F ±20% | |
| 额定电压 | 6. 3VDC | |
| 温度特性 | X6S(±22%) | |
| | 10% | |
| | $14 \mathrm{M}\Omega$ | |

| | 其他 |
|----------|--------------|
| 焊接方法 | 流体 |
| 库按方法 | 回流 |
| AEC-Q200 | NO |
| 包装形式 | 纸编带(180mm卷筒) |
| 包装个数 | 4000pcs |

 $!\ \mbox{Images}$ are for reference only and show exemplary products.

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特性图表(这是参考数据,并不保证产品的特性。)

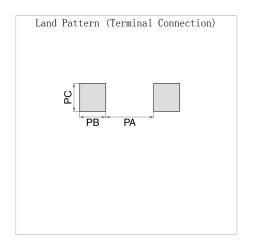
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Associated Images



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